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Vishay Siliconix

N-Channel 8 V (D-S) MOSFET



Marking code: F2

| PRODUCT SUMMARY | | | | | |
|--|--------|--|--|--|--|
| V _{DS} (V) | 8 | | | | |
| $R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$ | 0.017 | | | | |
| $R_{DS(on)}$ max. (Ω) at $V_{GS} = 2.5 \text{ V}$ | 0.020 | | | | |
| $R_{DS(on)}$ max. (Ω) at $V_{GS} = 1.8 \text{ V}$ | 0.022 | | | | |
| $R_{DS(on)}$ max. (Ω) at $V_{GS} = 1.5 \text{ V}$ | 0.030 | | | | |
| $R_{DS(on)}$ max. (Ω) at $V_{GS} = 1.2 \text{ V}$ | 0.075 | | | | |
| Q _g typ. (nC) | 6 | | | | |
| I _D (A) a, e | 6 | | | | |
| Configuration | Single | | | | |

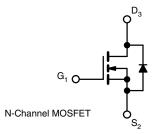
FEATURES

- TrenchFET® power MOSFET
- · Low on-resistance
- 100 % R_q tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- · Load switches for low voltage gate drive
- · Low voltage operating circuits
 - Gate drive 1.2 V to 5 V



| ORDERING INFORMATION | |
|---------------------------------|-----------------|
| Package | SOT-23 |
| Lead (Pb)-free and halogen-free | Si2342DS-T1-GE3 |

| PARAMETER | | SYMBOL | LIMIT | UNIT | |
|--|------------------------|-----------------------------------|---------------------|------|--|
| Drain-source voltage | | V_{DS} | 8 | V | |
| Gate-source voltage | | V _{GS} | ± 5 | v | |
| Continuous drain current (T _J = 150 °C) | T _C = 25 °C | | 6 ^e | | |
| | T _C = 70 °C | | 6 ^e | | |
| | T _A = 25 °C | I _D | 6 b, c, e | | |
| | T _A = 70 °C | <u> </u> | 5.8 ^{b, c} | A | |
| Pulsed drain current (t = 300 μs) | | I _{DM} | 30 | | |
| Continuous source-drain diode current | T _C = 25 °C | | 2.1 | | |
| | T _A = 25 °C | Is Is | 1.1 ^{b, c} | | |
| Maximum power dissipation | T _C = 25 °C | | 2.5 | | |
| | T _C = 70 °C | | 1.6 | 147 | |
| | T _A = 25 °C | P _D | 1.3 ^{b, c} | W | |
| | T _A = 70 °C | <u> </u> | 0.8 b, c | | |
| Operating junction and storage temperature range | | T _J , T _{stg} | -55 to +150 | | |
| Soldering recommendations (peak temperature) | | | 260 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | | |
|----------------------------------|--------------|--------------------|---------|---------|--------|--|--|
| PARAMETER | | SYMBOL | TYPICAL | MAXIMUM | UNIT | | |
| Maximum junction-to-ambient b, d | t ≤ 5 s | R _{thJA} | 75 | 100 | °C/W | | |
| Maximum junction-to-foot (drain) | Steady state | R _{th IE} | 40 | 50 | 7 0/00 | | |

Notes

- a. Based on T_C = 25 °C
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
 d. Maximum under steady state conditions is 166 °C/W
- e. Package limited



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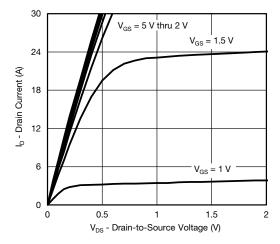
| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT | |
|---|-------------------------|--|------|-------|-------|-------|--|
| Static | | | | | | • | |
| Drain-source breakdown voltage | V_{DS} | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 8 | - | - | V | |
| V _{DS} temperature coefficient | $\Delta V_{DS}/T_{J}$ | 1 050 A | - | 10 | - | mV/°C | |
| V _{GS(th)} temperature coefficient | $\Delta V_{GS(th)}/T_J$ | I _D = 250 μA | - | -2.5 | - | | |
| Gate-source threshold voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_{D} = 250 \mu A$ | 0.35 | - | 0.8 | V | |
| Gate-source leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 5 \text{ V}$ | - | - | ± 100 | nA | |
| Zana anta alla anta da di | , | V _{DS} = 8 V, V _{GS} = 0 V | - | - | 1 | | |
| Zero gate voltage drain current | I _{DSS} | V _{DS} = 8 V, V _{GS} = 0 V, T _J = 70 °C | - | - | 10 | μA | |
| On-state drain current ^a | I _{D(on)} | $V_{DS} \le 5 \text{ V}, V_{GS} = 4.5 \text{ V}$ | 20 | - | - | Α | |
| | | V _{GS} = 4.5 V, I _D = 7.2 A | - | 0.014 | 0.017 | 1 | |
| | | $V_{GS} = 2.5 \text{ V}, I_D = 6.7 \text{ A}$ | - | 0.016 | 0.020 | | |
| Drain-source on-state resistance a | R _{DS(on)} | V _{GS} = 1.8 V, I _D = 6.4 A | - | 0.018 | 0.022 | Ω | |
| | | V _{GS} = 1.5 V, I _D = 5.5 A | - | 0.020 | 0.030 | | |
| | | V _{GS} = 1.2 V, I _D = 1.3 A | - | 0.025 | 0.075 | | |
| Forward transconductance ^a | 9 _{fs} | V _{DS} = 4 V, I _D = 7.2 A | - | 75 | - | S | |
| Dynamic ^b | · · · · | | | | | | |
| Input capacitance | C _{iss} | | - | 1070 | - | pF | |
| Output capacitance | C _{oss} | $V_{DS} = 4 V$, $V_{GS} = 0 V$, $f = 1 MHz$ | - | 385 | - | | |
| Reverse transfer capacitance | C _{rss} | | - | 200 | - | | |
| Total gate charge | | $V_{DS} = 4 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 7.2 \text{ A}$ | - | 10.5 | 15.8 | nC | |
| Total gate charge | Qg | | - | 6 | 9 | | |
| Gate-source charge | Q _{gs} | $V_{DS} = 4 \text{ V}, V_{GS} = 2.5 \text{ V}, I_D = 7.2 \text{ A}$ | - | 1.6 | - | | |
| Gate-drain charge | Q_{gd} | | - | 1 | - | | |
| Gate resistance | R_g | f = 1 MHz | 2.4 | 12 | 24 | Ω | |
| Turn-on delay time | t _{d(on)} | | - | 6 | 12 | ns | |
| Rise time | t _r | $V_{DD} = 4 \text{ V}, R_{L} = 0.7 \Omega,$ | - | 14 | 20 | | |
| Turn-off delay time | t _{d(off)} | $I_D \cong 5.8 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$ | - | 65 | 98 | | |
| Fall time | t _f | | - | 25 | 38 | | |
| Drain-Source Body Diode Characterist | cs | | | | | | |
| Continuous source-drain diode current | I _S | T _C = 25 °C | - | - | 2.1 | | |
| Pulse diode forward current | I _{SM} | | - | - | 30 | Α | |
| Body diode voltage | V_{SD} | I _S = 5.8 A, V _{GS} = 0 | - | 0.82 | 1.2 | V | |
| Body diode reverse recovery time | t _{rr} | | - | 40 | 60 | ns | |
| Body diode reverse recovery charge | Q _{rr} | $I_F = 5.8 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$ | - | 17 | 26 | nC | |
| Reverse recovery fall time | ta | T _J = 25 °C | - | 15 | - | | |
| Reverse recovery rise time | t _b | | - | 25 | - | ns | |

Notes

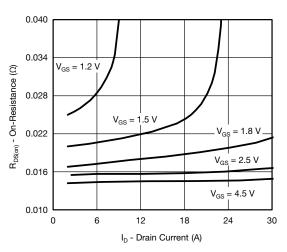
- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

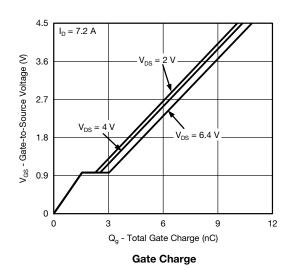


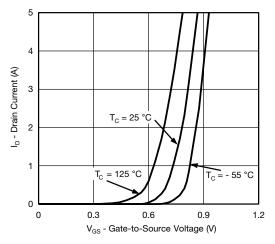


Output Characteristics

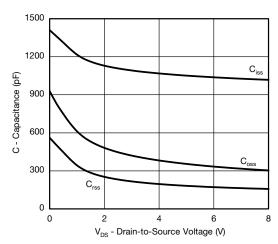


On-Resistance vs. Drain Current and Gate Voltage

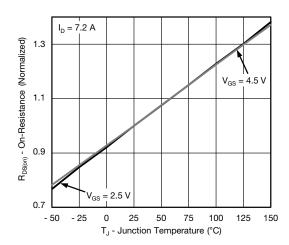




Transfer Characteristics

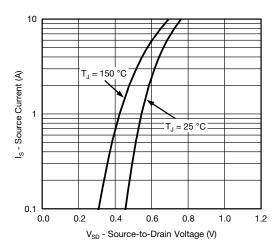


Capacitance

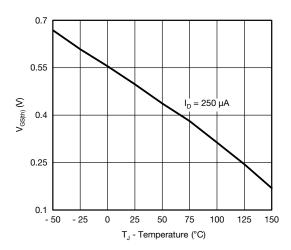


On-Resistance vs. Junction Temperature

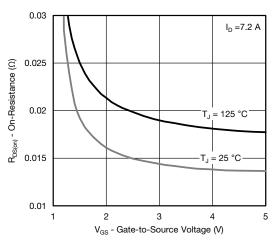




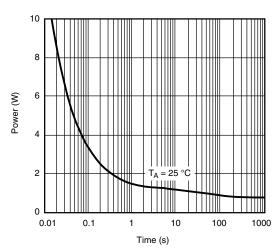
Source-Drain Diode Forward Voltage



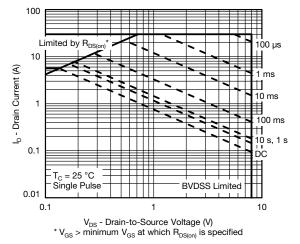
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage

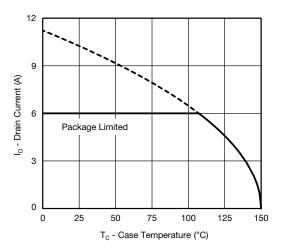


Single Pulse Power (Junction-to-Ambient)

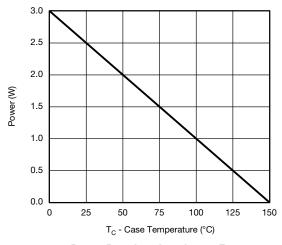


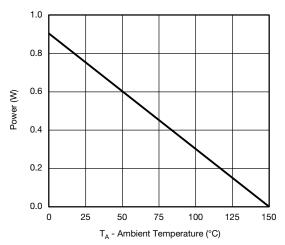
Safe Operating Area, Junction-to-Ambient





Current Derating a





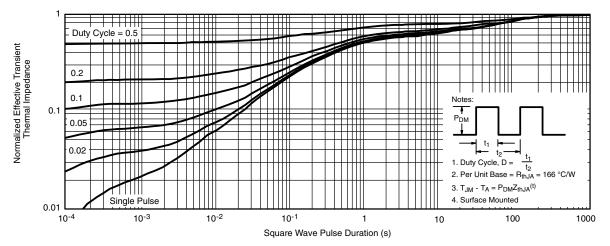
Power Derating, Junction-to-Foot

Power Derating, Junction-to-Ambient

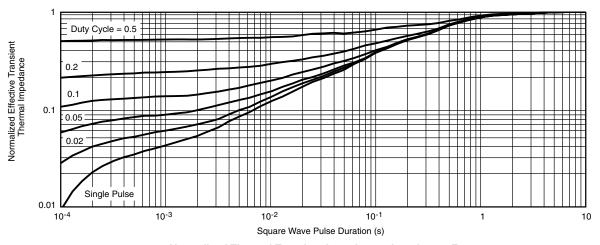
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?63302.

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SOT-23 (TO-236): 3-LEAD







| Dim | MILLI | METERS | INCHES | | |
|------------------------|----------|--------|------------|-------|--|
| | Min | Max | Min | Max | |
| Α | 0.89 | 1.12 | 0.035 | 0.044 | |
| A ₁ | 0.01 | 0.10 | 0.0004 | 0.004 | |
| A ₂ | 0.88 | 1.02 | 0.0346 | 0.040 | |
| b | 0.35 | 0.50 | 0.014 | 0.020 | |
| С | 0.085 | 0.18 | 0.003 | 0.007 | |
| D | 2.80 | 3.04 | 0.110 | 0.120 | |
| E | 2.10 | 2.64 | 0.083 | 0.104 | |
| E ₁ | 1.20 | 1.40 | 0.047 | 0.055 | |
| е | 0.95 BSC | | 0.0374 Ref | | |
| e ₁ | 1.90 BSC | | 0.0748 Ref | | |
| L | 0.40 | 0.60 | 0.016 | 0.024 | |
| L ₁ | 0.64 Ref | | 0.025 Ref | | |
| S | 0.50 Ref | | 0.020 Ref | | |
| q | 3° | 8° | 3° | 8° | |
| FCN: S-03946-Rev K 09- | lul-01 | • | | | |

ECN: S-03946-Rev. K, 09-Jul-01

DWG: 5479

Document Number: 71196 www.vishay.com 09-Jul-01



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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